PC457

■ Features

- 1. High resistance to noise (CMR:MIN. 15kV/µs)
- 2. High speed response (tphl:MAX. 0.8µs, tplh:MAX. 0.8µs)
- 3. Mini-flat package
- 4. Isolation voltage (Viso (rms):2.5kV)
- 5. Recognized by UL, file No. E64380

■ Applications

- 1. Programmable controller
- 2. Inverter

■ Package Specifications

Model No.	Package specification	Diameter of reel	Tape width
PC457	Taping package (3 000pcs.)	ф370mm	13.5mm
PC457T	Taping package (750pcs.)	φ180mm	13.5mm

■ Absolute Maximum Ratings

-	T_{α}	.—Դ	5 0	\sim
(16	ı=2	J	C)

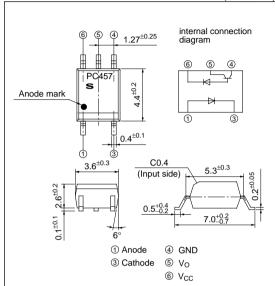
	Parameter	Symbol	Rating	Unit	
'	*1 Forward current	IF	25	mA	
Input	Reverse voltage	VR	5	V	
	*2 Power dissipation	P	45	mW	
	Supply voltage	Vcc	-0.5 to +30	V	
Output	Output voltage	Vo	-0.5 to +20	V	
	Output current	Io	8	mA	
	*3 Power dissipation	Po	100	mW	
*3 Total power dissipation		Ptot	100	mW	
	*4 Isolation voltage		2.5	kV	
	Operating temperature	Topr	-40 to +100	°C	
Storage temperature		Tstg	-40 to +125	°C	
	*5 Soldering temperature	Tsol	260	°C	

^{*1} When ambient temperature goes above 70°C, the power dissipation goes down at 0.45mA/°C.

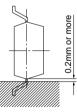
High Speed and High CMR OPIC Photocoupler

■ Outline Dimensions





* "OPIC" (Optical IC) is a trademark of the SHARP Corporation. An OPIC consists of a light-detecting element and signal-processing circuit integrated onto a single chip.



Soldening area

^{*2} When ambient temperature goes above 70°C, the power dissipation goes down at 0.8mA/°C.

^{*3} When ambient temperature goes above 70°C, the power dissipation goes down at 1.8mA/°C.

^{*4 40} to 60% RH, AC for 1 min

^{*5} For 10 s

■ Elect	ro-optical Characteristics	5	(Unle	ss otherwi	ise specifi	ied Ta=0 t	io +70°C)
Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	V _F	I _F =16mA	_	1.7	1.95	V
	Reverse current	Ir	V _R =5V	_	_	10	μΑ
	Terminal capacitance	Ct	V _F =0V, f=1MHz	_	60	250	pF
Output	High level output current (1)	IOH (1)	I _F =0mA, V _{CC} =5.5V, V _O =5.5V	_	3	500	nA
	High level output current (2)	IOH (2)	I _F =0mA, V _{CC} =15V, V _O =15V	_	_	1.0	μΑ
	*6 High level output current (3)	IOH (3)	I _F =0mA, V _{CC} =15V, V _O =15V	_	_	50	μΑ
	High level supply current (1)	ICCH (1)	I _F =0mA, V _{CC} =15V, V _O =open	_	0.02	1.0	μΑ
	*6 High level supply current (2)	ICCH (2)	I _F =0mA, V _{CC} =15V, V _O =open	_	_	2.0	μΑ
	Low level supply current	Iccl	I=16mA, Vcc=15V, Vo=open	_	200	_	μΑ
	Low level output voltage	Vol	I _F =16mA, V _{CC} =4.5V, I _O =2.4mA	_	_	0.4	V
	Current transfer ratio (1)	CTR (1)	I _F =16mA, V _{CC} =4.5V, V _O =0.4V	19	_	50	%
	*6 Current transfer ratio (2)	CTR (2)	I _F =16mA, V _{CC} =4.5V, V _O =0.4V	15	_	-	%
	*7 "High→Low" propagation delay time	tрнL	I _F =16mA, V _{CC} =5V	_	0.2	0.8	μs
	*7 "Low→High" propagation delay time	t _p LH	$R_L=1.9\Omega$	_	0.6	0.8	μs
Transfer charac- teristics	*8 Instantaneous common mode rejection voltage "Output : High level"	СМн	$I_F\!\!=\!\!0mA,R_L\!\!=\!\!1.9k\Omega$ $V_{CC}\!\!=\!\!5V,V_{CM(p\!-\!p)}\!\!=\!\!1.0kV$	15	30	_	kV/μs
	*8 Instantaneous common mode rejection voltage "Output : Low level"	CML	$I_F=16mA,R_L=1.9k\Omega \\ V_{CC}=5V,V_{CM(p-p)}=1.0kV$	-15	-30	-	kV/μs
	Isolation resistance	Riso	DC=500V, 40 to 60%RH	5×10 ¹⁰	1×10 ¹¹	-	Ω
	Floating capacitance	Cf	V=0V, f=1MHz	_	0.6	1.0	pF

^{*6} Ta=0 to 70°C

Fig.1 Test Circuit for Propagation Delay Time

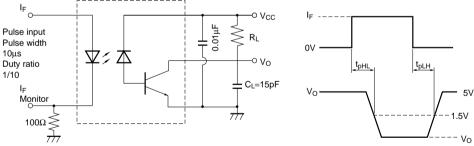
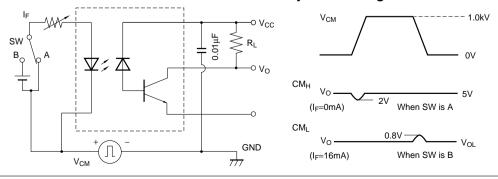


Fig.2 Test Circuit for Instantaneous Common Mode Rejection Voltage



^{*7} Refer to Fig.1

^{*8} Refer to Fig.2

^{*9} Each characteristic shall be measured under shielded from the light

PC457

Fig.3 Forward Current vs. Ambient Temperature

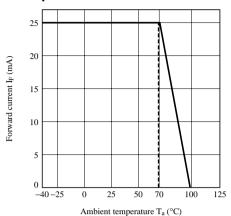
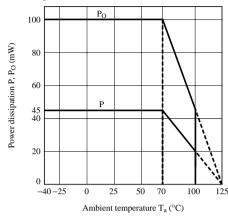


Fig.4 Power Dissipation vs. Ambient Temperature



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